

N-Channel 20-V (D-S) Fast Switching MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A)		
20	0.0065 at $V_{GS} = 4.5 \text{ V}$	22		
	0.009 at V _{GS} = 2.5 V	19		

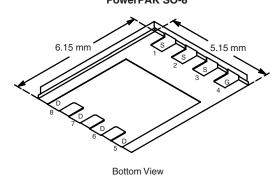
FEATURES

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET[®] Power MOSFET
- New Low Thermal Resistance PowerPAK[®] Package with Low 1.07 mm Profile
- 100 % R_g Tested





PowerPAK SO-8

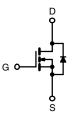


Ordering Information: Si7448DP-T1-E3 (Lead (Pb)-free)

Si7448DP-T1-GE3 (Lead (Pb)-free and Halogen-free)

APPLICATIONS

- · Synchronous Rectifier Low Output Voltage
- · Portable Computer Battery Selection or Protection



N-Channel MOSFET

Parameter		Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V_{DS}	20		V	
Gate-Source Voltage		V_{GS}	± 12			
Continuous Drain Current (T = 150°C)8	T _A = 25°C	I _D	22	13.4	^	
Continuous Drain Current (T _J = 150°C) ^a	T _A = 70°C		17.6	10.7		
Pulsed Drain Current		I _{DM}	50		Α	
Continuous Source Current (Diode Conduction) ^a		I _S	4.3	1.6		
Maximum Power Dissipation ^a	T _A = 25°C	P _D	5.2	1.9	W	
Maximum Fower Dissipation	T _A = 70°C		3.3	1.2		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	
Soldering Recommendations (Peak Temperature) ^{b, c}			260			

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^a	t ≤ 10 s	R _{thJA}	19	24			
Maximum Sunction-to-Ambient	Steady State	' 'thJA	52	65	°C/W		
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	1.5	1.8			

Notes

- a. Surface Mounted on 1" x 1" FR4 board.
- b. See Solder Profile (<u>www.vishay.com/ppg?73257</u>). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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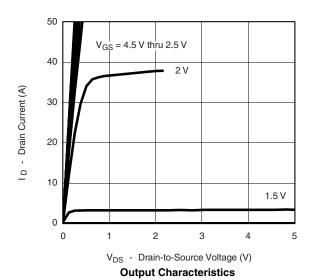


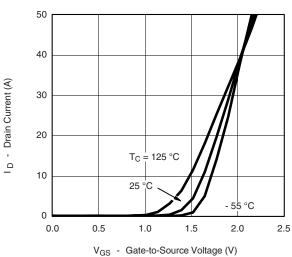
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.6		1.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			±100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 20 V, V _{GS} = 0 V			1	μΑ	
		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85^{\circ}\text{C}$			20		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	50			Α	
Drain-Source On-State Resistance ^a		$V_{GS} = 4.5 \text{ V}, I_D = 22 \text{ A}$		0.0054	0.0065	Ω	
	R _{DS(on)}	$V_{GS} = 2.5 \text{ V}, I_D = 19 \text{ A}$		0.0075	0.009		
Forward Transconductance ^a	g _{fs}	V _{DS} = 15 V, I _D = 22 A		90		S	
Diode Forward Voltage ^a	V_{SD}	$I_S = 3 A, V_{GS} = 0 V$		0.8	1.2	V	
Dynamic ^b	<u> </u>				<u>l</u>		
Total Gate Charge	Q_g			38	50		
Gate-Source Charge	Q _{gs} Q _{gd}	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 21 \text{ A}$		8		nC	
Gate-Drain Charge				8.5			
Gate Resistance	R_g		0.2	0.9	1.1	Ω	
Turn-On Delay Time	t _{d(on)}			22	35		
Rise Time	t _r	V_{DD} = 10 V, R_L = 10 Ω		22	35		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 1.0 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$		125	190	ns	
Fall Time	t _f			60	90		
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 3 A, dI/dt = 100 A/μs		60	90		

- a. Pulse test; pulse width \le 300 μ s, duty cycle \le 2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





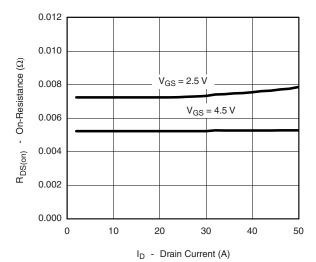
Transfer Characteristics



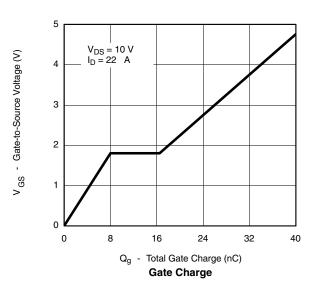




TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



On-Resistance vs. Drain Current



T_J = 150 °C

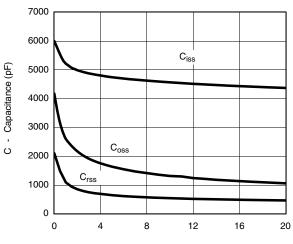
T_J = 150 °C

T_J = 25 °C

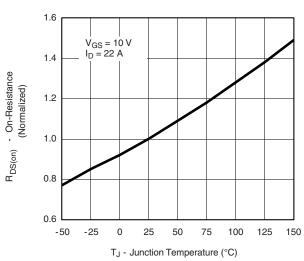
T_J = 25 °C

V_{SD} - Source-to-Drain Voltage (V)

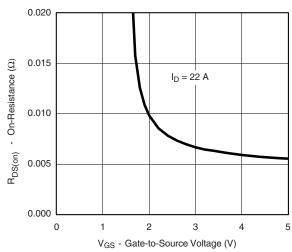
Source-Drain Diode Forward Voltage



V_{DS} - Drain-to-Source Voltage (V) **Capacitance**



On-Resistance vs. Junction Temperature



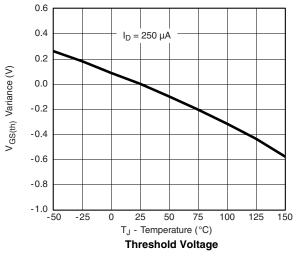
On-Resistance vs. Gate-to-Source Voltage

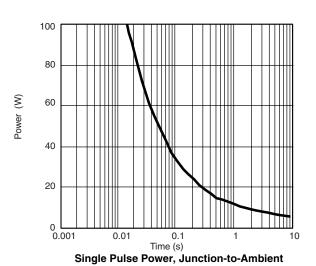
Is - Source Current (A)

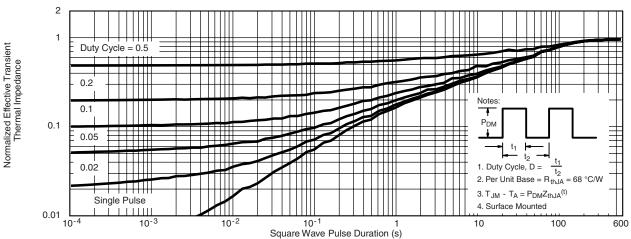
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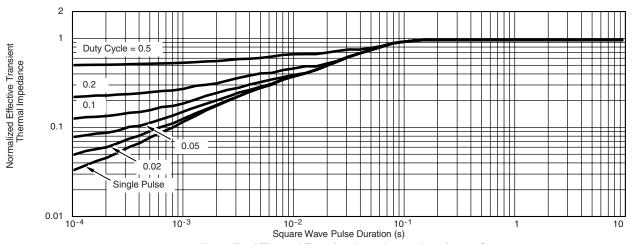
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted







Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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